IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| • | Unit: 2818 DANG, PHUC T |
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| APPLICATION Of: | DANO, I NOC I |
| : Naofumi IWAMOTO |) |
| : To Be Assigned |) |
| : 10/197,529 |) |
| : herewith |))) DDEL IMINIA DV |
| : METHOD OF MANUFACTURING SEMICONDUCTOR CHIP HAVING A SUPPORTING MEMBER AND SEMICONDUCTOR PACKAGE HAVIN THE SEMICONDUCTOR CHIP(amen | , |
| : F00ED0440-DIV |)) |
| for Patents | November 21, 2003 |
| | Examiner: APPLICATION Of: Naofumi IWAMOTO To Be Assigned 10/197,529 herewith METHOD OF MANUFACTURING SEMICONDUCTOR CHIP HAVING A SUPPORTING MEMBER AND SEMICONDUCTOR PACKAGE HAVII THE SEMICONDUCTOR CHIP(amen |

P. O. Box 1450

Alexandria, VA 22313-1450

Sir:

Preliminary to examination, please amend the application as follows: